

## Aufsteckkühlkörper

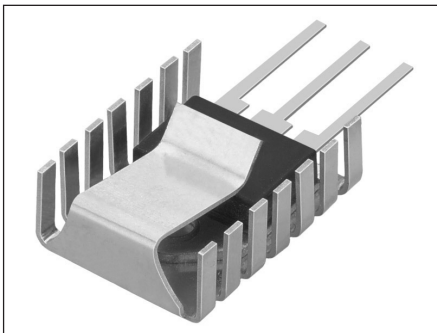
## Clip-on heatsinks

## Dissipateurs enfichables

- universeller Aufsteckkühlkörper für die Bauformen TO 218, TO 220, TO 247, TO 248, SIP-Multiwatt und ähnliche
- einfache Montage durch aufschieben des Kühlkörpers auf das Bauteil
- für vertikale und horizontale Einlötbefestigung
- Variationen der Rippenhöhe auf Anfrage
- Sonderausführungen nach kundenspezifischen Vorgaben

- universal clip-on heatsinks for type TO 218, TO 229, TO 247, TO 248, SIP-Multiwatt and similar housings
- easy assembly by pushing the heatsink onto the component
- for vertical and horizontal fastening by soldering
- fin height variations on request
- versions specifically designed to meet customers requirements on request

- dissipateur enfichable universel pour boîtiers de transistor TO 218, TO 220, TO 247, TO 248, SIP-Multiwatt et similaires
- montage facile par enfilage du dissipateur sur le boîtier
- pour fixation verticale et horizontale par soudure
- variations de l'hauteur des ailettes sur demande
- versions spéciales suivant spécifications du client



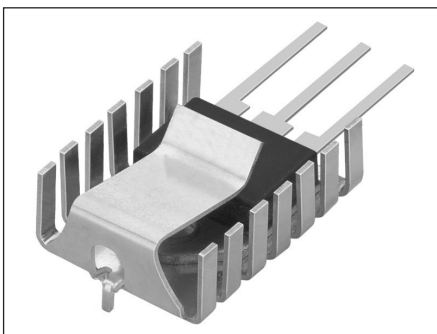
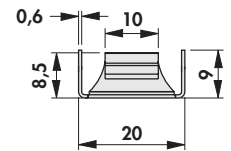
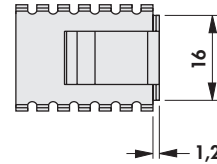
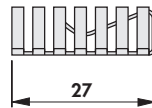
**FK 245 MI 247 O**

20,2 K/W

ohne Lötflanke

without solder lug

sans paillette picot



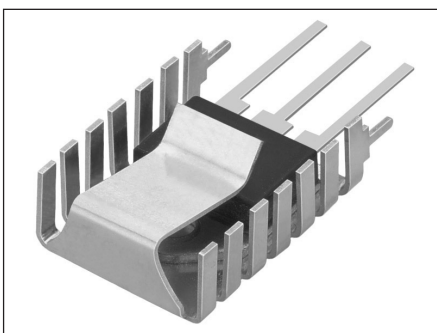
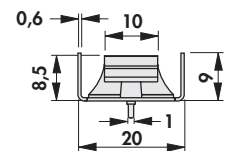
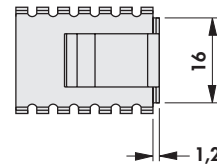
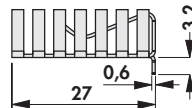
**FK 245 MI 247 H**

20,5 K/W

mit Lötflanke für horizontalen Einbau

with solder lug for horizontal installation

avec paillette picot pour montage horizontal



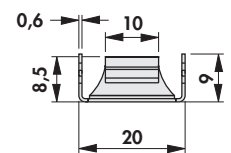
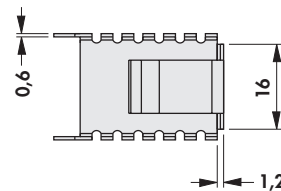
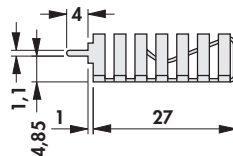
**FK 245 MI 247 V**

19,7 K/W

mit Lötflanke für vertikalen Einbau

with solder lug for vertical installation

avec paillette picot pour montage vertical



**Material:** Kupfer (Cu), 0,6 mm dick  
**Oberfläche:** lötfähig

**Material:** copper (Cu), 0,6 mm thick  
**Surface:** solderable

**Matériau:** Cuivre (Cu), épaisseur 0,6 mm  
**Revêtement:** Soudable